

REV.	LOCAS.	DESCRIPTION	DATE	DRAWN
02	△	變更新料號	2009.09.15	孫元
03	△	料號錯誤, 修正料號	2010.02.23	孫元
04	△	變更新圖號, 修改注解	2011.09.20	李劍峰

MATERIAL:

CONTACT: COPPER,GOLD AND TIN PLATED,
NICKEL UNDER PLATED.

HOUSING.COVER: Thermoplastic,UL 94V-0 PBT
or the equivalent material. △

All materials must meet Greenconn
requirement for environment protection

RATING:

VOLTAGE:125V AC

CURRENT:0.5AMPERE

TEMPERATURE:-40°C TO 80°C.

3.TEST REQUIREMENT AND PROCEDURES SUMMARY:

ELECTRICAL:

TERMINATION RESISTANCE: 25mΩ MAX.

DIELECTRIC WITHSTANDING VOLTAGE:300 V AC.

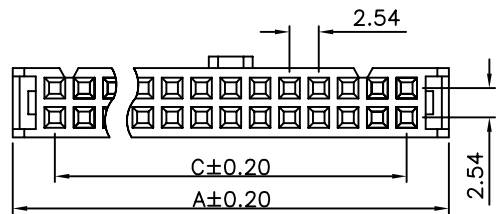
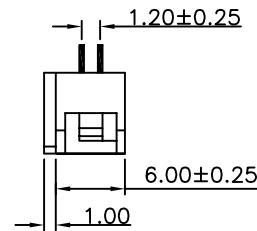
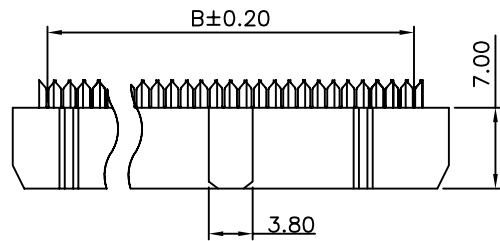
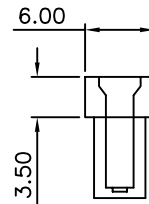
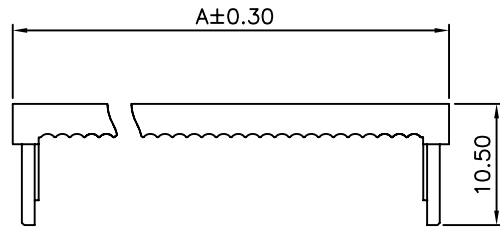
INSULATION RESISTANCE: 5000MΩ (BEFORE TEST)

INSULATION RESISTANCE: 1000MΩ (BEHIND TEST)

MECHANICAL:

MATING FORCE:1.67N MAX PER CONTACT.

UNMATING FORCE:0.14N MIN PER CONTACT.



Ordering Information

C QHA215 - XX XX A001 A 1 B X -23△△△

No. of Pins per Row
3, 4, 5, 6, 7, 8, 9
10, 12, 13, 15, 17, 18, 20
22, 25, 30, 32

Contact Plating
70=Gold Flash on contact area, B=TRAY(十行盒)
Ni plating on the balance
Duplex Plating
05=Gold Flash/Tin Standard
...

PIN Q'TY	A	B	C
2*3	12.22	6.35	5.08
2*4	14.76	8.89	7.62
2*5	17.30	11.43	10.16
2*6	19.84	13.97	12.70
2*7	22.38	16.51	15.24
2*8	25.02	19.05	17.78
2*9	27.46	21.59	20.32
2*10	30.00	24.13	22.86
2*12	35.08	29.21	27.94
2*13	37.62	31.75	30.48
2*15	42.70	36.83	35.56
2*17	47.78	41.91	40.64
2*18	50.32	44.45	43.18
2*20	55.80	49.53	48.26
2*22	60.48	54.61	53.34
2*25	68.10	62.23	60.96
2*30	80.80	74.93	73.66
2*32	85.88	80.01	78.74

格稜股份有限公司
Greenconn Corporation

GENERAL TOLERANCE

X. ± 5°	.X ° ±
X. ± 2°	.X ± 0.25
XX. ± 1°	.XX ± 0.20
XXX. ± 0.5°	.XXX ± 0.13

DRAWN 李劍峰

DATE 2011.09.20

CHECK 李新華

DATE 2011.09.20

APPROVE LINK

DATE 2011.09.20

DWG. NO. △△△

CQHA215 - CAIAB

PART NO. △△△

CQHA215 - XXXXA001A1BX -23

TITLE

FC 系列 《青銅》

REV.	UNIT	SCALE
04	mm	2:1